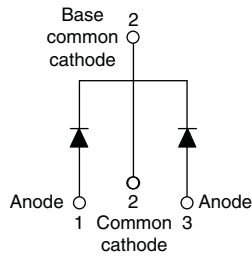


Schottky Rectifier, 2 x 15 A


TO-220AB


FEATURES

- 150 °C T_J operation
- Very low forward voltage drop
- High frequency operation
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- Guard ring for enhanced ruggedness and long term reliability
- Compliant to RoHS Directive 2002/95/EC
- Designed and qualified according to JEDEC-JESD47
- Halogen-free according to IEC 61249-2-21 definition (-N3 only)



| PRODUCT SUMMARY | |
|----------------------------------|-----------------|
| Package | TO-220AB |
| I _{F(AV)} | 2 x 15 A |
| V _R | 50 V, 60 V |
| V _F at I _F | 0.56 V |
| I _{RM} max. | 45 mA at 125 °C |
| T _J max. | 150 °C |
| Diode variation | Common cathode |
| E _{AS} | 13 mJ |

DESCRIPTION

This center tap Schottky rectifier has been optimized for very low forward voltage drop, with moderate leakage. The proprietary barrier technology allows for reliable operation up to 150 °C junction temperature. Typical applications are in switching power supplies, converters, freewheeling diodes, and reverse battery protection.

| MAJOR RATINGS AND CHARACTERISTICS | | | |
|-----------------------------------|--|-------------|-------|
| SYMBOL | CHARACTERISTICS | VALUES | UNITS |
| I _{F(AV)} | Rectangular waveform | 30 | A |
| V _{RRM} | | 50/60 | V |
| I _{FSM} | t _p = 5 μs sine | 1000 | A |
| V _F | 15 A _{pk} , T _J = 125 °C (per leg) | 0.56 | V |
| T _J | Range | - 55 to 150 | °C |

| VOLTAGE RATINGS | | | | | | |
|--------------------------------------|------------------|----------------|----------------|----------------|----------------|-------|
| PARAMETER | SYMBOL | VS-30CTQ050PbF | VS-30CTQ050-N3 | VS-30CTQ060PbF | VS-30CTQ060-N3 | UNITS |
| Maximum DC reverse voltage | V _R | 50 | 50 | 60 | 60 | V |
| Maximum working peak reverse voltage | V _{RWM} | | | | | |

| ABSOLUTE MAXIMUM RATINGS | | | | | |
|---|--------------------|--|--|------------|-------|
| PARAMETER | SYMBOL | TEST CONDITIONS | | VALUES | UNITS |
| Maximum average forward current See fig. 5 | I _{F(AV)} | 50 % duty cycle at T _C = 105 °C, rectangular waveform | | 30 | A |
| | | | | per device | |
| Maximum peak one cycle non-repetitive surge current per leg See fig. 7 | I _{FSM} | 5 μs sine or 3 μs rect. pulse | Following any rated load condition and with rated V _{RRM} applied | 1000 | |
| | | 10 ms sine or 6 ms rect. pulse | | 260 | |
| Non-repetitive avalanche energy per leg | E _{AS} | T _J = 25 °C, I _{AS} = 1.50 A, L = 11.5 mH | | 13 | mJ |
| Repetitive avalanche current per leg | I _{AR} | Current decaying linearly to zero in 1 μs Frequency limited by T _J maximum V _A = 1.5 x V _R typical | | 1.50 | A |



| ELECTRICAL SPECIFICATIONS | | | | | |
|---|----------------|---|-----------------------------------|--------|------------|
| PARAMETER | SYMBOL | TEST CONDITIONS | | VALUES | UNITS |
| Maximum forward voltage drop per leg See fig. 1 | $V_{FM}^{(1)}$ | 15 A | $T_J = 25\text{ }^\circ\text{C}$ | 0.62 | V |
| | | 30 A | | 0.82 | |
| | | 15 A | $T_J = 125\text{ }^\circ\text{C}$ | 0.56 | |
| | | 30 A | | 0.71 | |
| Maximum reverse leakage current per leg See fig. 2 | $I_{RM}^{(1)}$ | $T_J = 25\text{ }^\circ\text{C}$ | $V_R = \text{Rated } V_R$ | 0.80 | mA |
| | | $T_J = 125\text{ }^\circ\text{C}$ | | 45 | |
| Threshold voltage | $V_{F(TO)}$ | $T_J = T_J \text{ maximum}$ | | 0.39 | V |
| Forward slope resistance | r_t | | | 8.47 | m Ω |
| Maximum junction capacitance per leg | C_T | $V_R = 5\text{ }V_{DC}$ (test signal range 100 kHz to 1 MHz) $25\text{ }^\circ\text{C}$ | | 720 | pF |
| Typical series inductance per leg | L_S | Measured lead to lead 5 mm from package body | | 8.0 | nH |
| Maximum voltage rate of change | dV/dt | Rated V_R | | 10 000 | V/ μ s |

Note

(1) Pulse width < 300 μ s, duty cycle < 2 %

| THERMAL - MECHANICAL SPECIFICATIONS | | | | | |
|--|----------------|--------------------------------------|--|-------------|------------------------|
| PARAMETER | SYMBOL | TEST CONDITIONS | | VALUES | UNITS |
| Maximum junction and storage temperature range | T_J, T_{Stg} | | | - 55 to 150 | $^\circ\text{C}$ |
| Maximum thermal resistance, junction to case per leg | R_{thJC} | DC operation | | 3.25 | $^\circ\text{C/W}$ |
| Maximum thermal resistance, junction to case per package | | | | 1.63 | |
| Typical thermal resistance, case to heatsink | R_{thCS} | Mounting surface, smooth and greased | | 0.50 | |
| Approximate weight | | | | 2 | g |
| | | | | 0.07 | oz. |
| Mounting torque | minimum | | | 6 (5) | kgf · cm (lbf · in) |
| | maximum | | | 12 (10) | |
| Marking device | | Case style TO-220AB | | 30CTQ050 | |
| | | | | 30CTQ060 | |

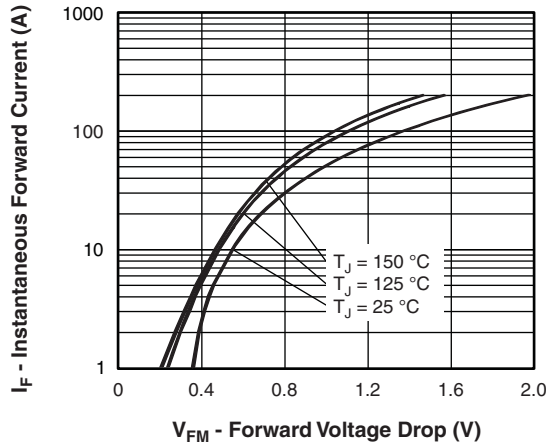


Fig. 1 - Maximum Forward Voltage Drop Characteristics (Per Leg)

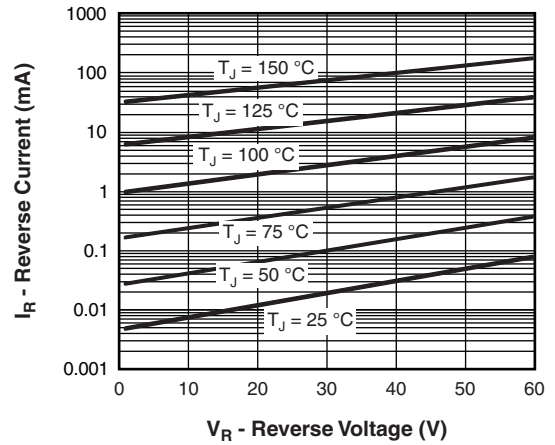


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage (Per Leg)

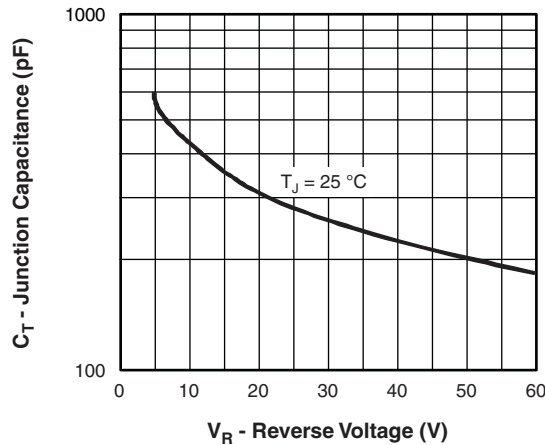


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage (Per Leg)

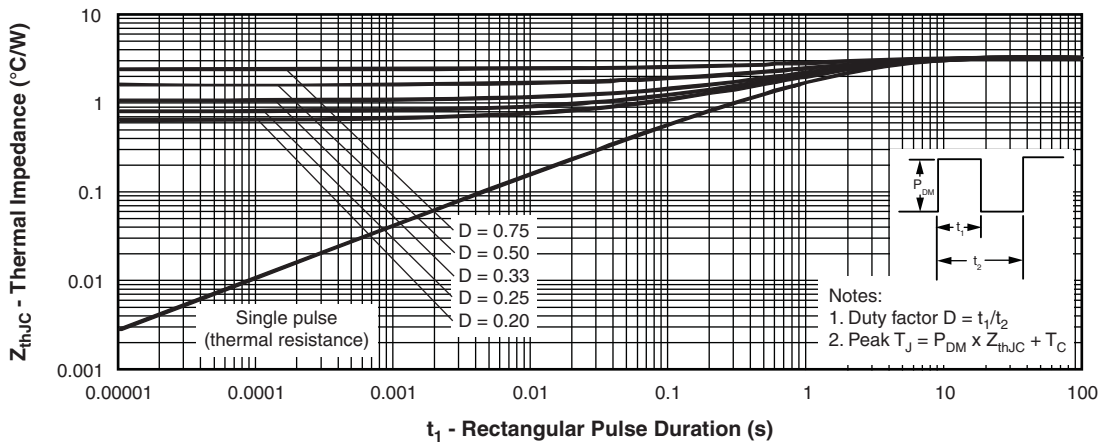


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics (Per Leg)

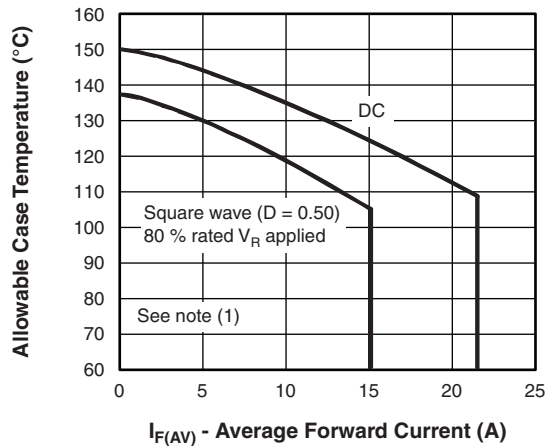


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current (Per Leg)

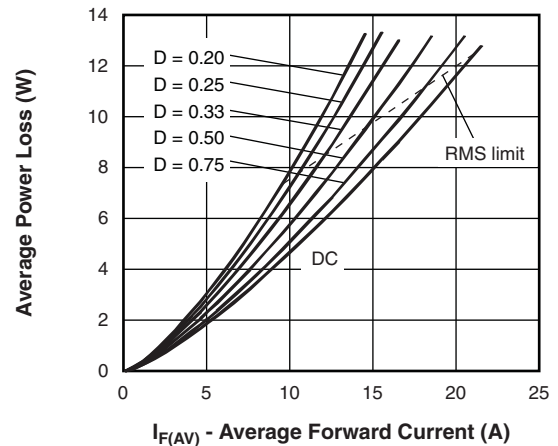


Fig. 6 - Forward Power Loss Characteristics (Per Leg)

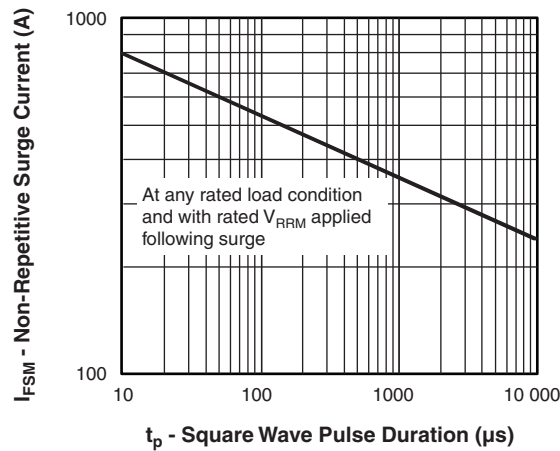


Fig. 7 - Maximum Non-Repitative Surge Current (Per Leg)

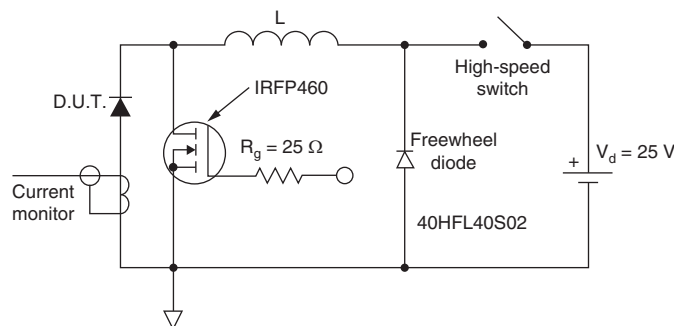


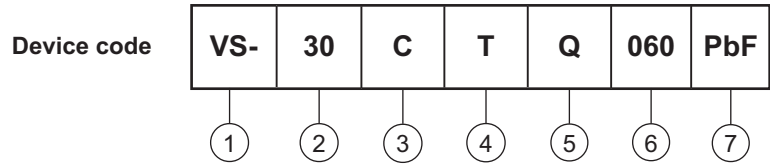
Fig. 8 - Unclamped Inductive Test Circuit

Note

- (1) Formula used: $T_C = T_J - (P_d + P_{d_{REV}}) \times R_{thJC}$;
- P_d = Forward power loss = $I_{F(AV)} \times V_{FM}$ at $(I_{F(AV)}/D)$ (see fig. 6);
- $P_{d_{REV}}$ = Inverse power loss = $V_{R1} \times I_R (1 - D)$; I_R at $V_{R1} = 10\text{ V}$



ORDERING INFORMATION TABLE



- 1** - Vishay Semiconductors product
- 2** - Current rating (30 = 30 A)
- 3** - Circuit configuration:
C = Common cathode
- 4** - Package:
T = TO-220
- 5** - Schottky "Q" series
- 6** - Voltage ratings

| |
|------------|
| 050 = 50 V |
| 060 = 60 V |
- 7** - Environmental digit
 - PbF = Lead (Pb)-free and RoHS compliant
 - -N3 = Halogen-free, RoHS compliant, and totally lead (Pb)-free

| ORDERING INFORMATION (Example) | | | |
|--------------------------------|------------------|------------------------|-------------------------|
| PREFERRED P/N | QUANTITY PER T/R | MINIMUM ORDER QUANTITY | PACKAGING DESCRIPTION |
| VS-30CTQ050PbF | 50 | 1000 | Antistatic plastic tube |
| VS-30CTQ050-N3 | 50 | 1000 | Antistatic plastic tube |
| VS-30CTQ060PbF | 50 | 1000 | Antistatic plastic tube |
| VS-30CTQ060-N3 | 50 | 1000 | Antistatic plastic tube |

| LINKS TO RELATED DOCUMENTS | |
|----------------------------|--|
| Dimensions | www.vishay.com/doc?95222 |
| Part marking information | TO-220ABPbF www.vishay.com/doc?95225 |
| | TO-220AB-N3 www.vishay.com/doc?95028 |

TO-220AB

DIMENSIONS in millimeters and inches



Lead assignments

Diodes

1. - Anode/open
2. - Cathode
3. - Anode

Conforms to JEDEC outline TO-220AB

| SYMBOL | MILLIMETERS | | INCHES | | NOTES |
|----------|-------------|-------|------------|-------|-------|
| | MIN. | MAX. | MIN. | MAX. | |
| A | 4.25 | 4.65 | 0.167 | 0.183 | |
| A1 | 1.14 | 1.40 | 0.045 | 0.055 | |
| A2 | 2.56 | 2.92 | 0.101 | 0.115 | |
| b | 0.69 | 1.01 | 0.027 | 0.040 | |
| b1 | 0.38 | 0.97 | 0.015 | 0.038 | 4 |
| b2 | 1.20 | 1.73 | 0.047 | 0.068 | |
| b3 | 1.14 | 1.73 | 0.045 | 0.068 | 4 |
| c | 0.36 | 0.61 | 0.014 | 0.024 | |
| c1 | 0.36 | 0.56 | 0.014 | 0.022 | 4 |
| D | 14.85 | 15.25 | 0.585 | 0.600 | 3 |
| D1 | 8.38 | 9.02 | 0.330 | 0.355 | |
| D2 | 11.68 | 12.88 | 0.460 | 0.507 | 6 |
| E | 10.11 | 10.51 | 0.398 | 0.414 | 3, 6 |
| E1 | 6.86 | 8.89 | 0.270 | 0.350 | 6 |
| E2 | - | 0.76 | - | 0.030 | 7 |
| e | 2.41 | 2.67 | 0.095 | 0.105 | |
| e1 | 4.88 | 5.28 | 0.192 | 0.208 | |
| H1 | 6.09 | 6.48 | 0.240 | 0.255 | 6, 7 |
| L | 13.52 | 14.02 | 0.532 | 0.552 | |
| L1 | 3.32 | 3.82 | 0.131 | 0.150 | 2 |
| ϕP | 3.54 | 3.73 | 0.139 | 0.147 | |
| Q | 2.60 | 3.00 | 0.102 | 0.118 | |
| θ | 90° to 93° | | 90° to 93° | | |

Notes

- (1) Dimensioning and tolerancing as per ASME Y14.5M-1994
- (2) Lead dimension and finish uncontrolled in L1
- (3) Dimension D, D1 and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- (4) Dimension b1, b3 and c1 apply to base metal only
- (5) Controlling dimensions: inches
- (6) Thermal pad contour optional within dimensions E, H1, D2 and E1
- (7) Dimensions E2 x H1 define a zone where stamping and singulation irregularities are allowed
- (8) Outline conforms to JEDEC TO-220, except A2 (maximum) and D2 (minimum) where dimensions are derived from the actual package outline



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